FS3400

N-Channel SMD MOSFET

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	I_D
30V	28mΩ@10V	5.8A
	31mΩ@4.5V	
	45mΩ@2.5V	

Feature

- Advanced trench process technology
- High density cell design for ultra low on-resistance

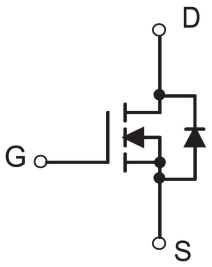
Application

- Load Switch for Portable Devices
- DC/DC Converter

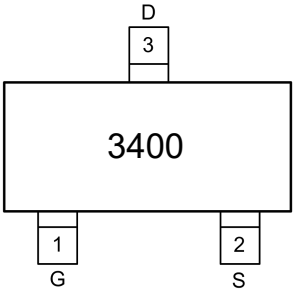
Package

SOT-23

Circuit diagram



Marking



Absolute maximum ratings (Ta=25℃ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	±12	V
Continuous Drain Current	I_D	5.8	A
Pulsed Drain Current	I_{DM}	30	A
Power Dissipation	P_D	1.4	W
Junction Temperature	T_J	-55 ~ +150	℃
Storage Temperature	T_{STG}	-55 ~ +150	℃

Electrical characteristics (T_A=25 °C, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-source breakdown voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D =250μA	30			V
Zero gate voltage drain current	I_{DSS}	V_{DS} =30V,V_{GS} = 0V			1.0	μA
Gate-body leakage current	I_{GSS}	V_{GS} =±12V, V_{DS} = 0V			±100	nA
Gate threshold voltage	$V_{GS(th)}$	V_{DS} =V_{GS}, I_D =250μA	0.7	0.9	1.4	V
Drain-source on-resistance[1]	$R_{DS(on)}$	V_{GS} =10V, I_D =2.9A		28	35	mΩ
		V_{GS} =4.5V, I_D =2.9A		31	40	
		V_{GS} =2.5V, I_D =4A		45	50	
Dynamic characteristics[2]						
Input Capacitance	C_{iss}	V_{DS} =15V,V_{GS} =0V,f =1MHz		620		pF
Output Capacitance	C_{oss}			100		
Reverse Transfer Capacitance	C_{rss}			80		
Total Gate Charge	Q_g	V_{DS} =15V,V_{GS} =4.5V, I_D =4.5A		9.5		nC
Gate-Source Charge	Q_{gs}			1.5		
Gate-Drain Charge	Q_{gd}			3		
Turn-on delay time	$t_{d(on)}$	V_{DD}=15V, V_{GS} =10V, R_{GEN}=3Ω, I_D=2.9A		3.3		nS
Turn-on rise time	t_r			4.8		
Turn-off delay time	$t_{d(off)}$			26		
Turn-off fall time	t_f			4		
Source-Drain Diode characteristics						
Diode Forward Current[1]	I_S				5.8	A
Diode Forward voltage	V_{DS}	V_{GS} =0V, I_S=2.9A			1.2	V

Notes:

1) Pulse Test: Pulse Width < 300μs, Duty Cycle ≤2%.

2) Guaranteed by design, not subject to production testing.

Typical Characteristics

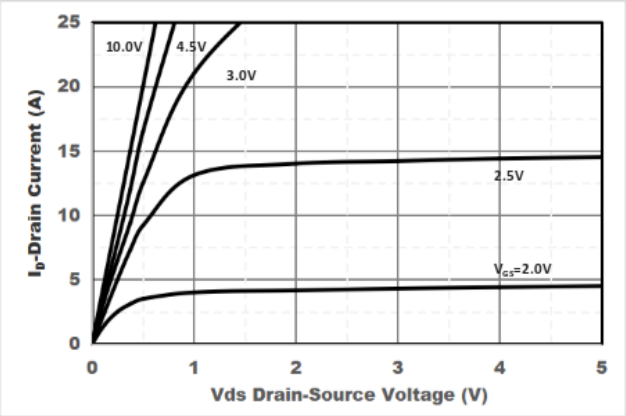


Figure1. Output Characteristics

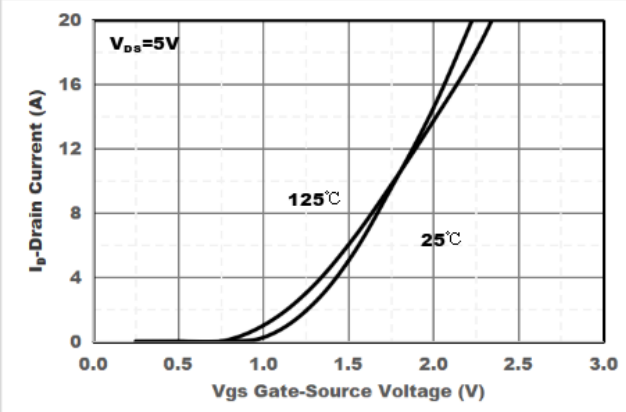


Figure2. Transfer Characteristics

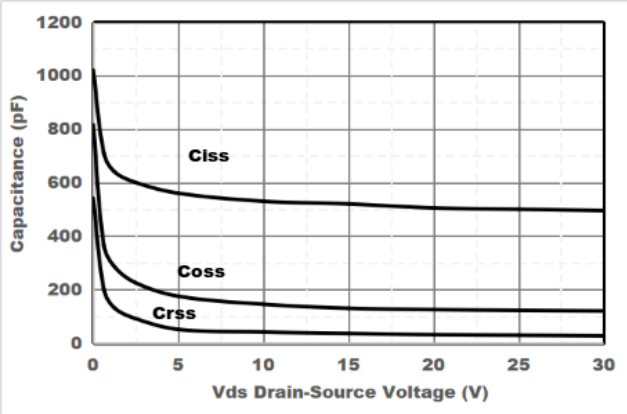


Figure3. Capacitance Characteristics

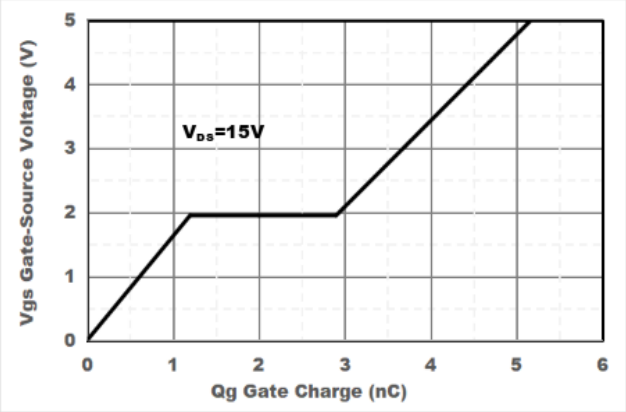


Figure4. Gate Charge

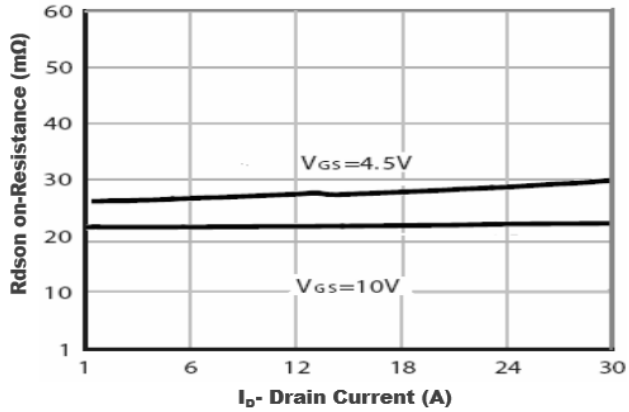


Figure5. Drain-Source on Resistance

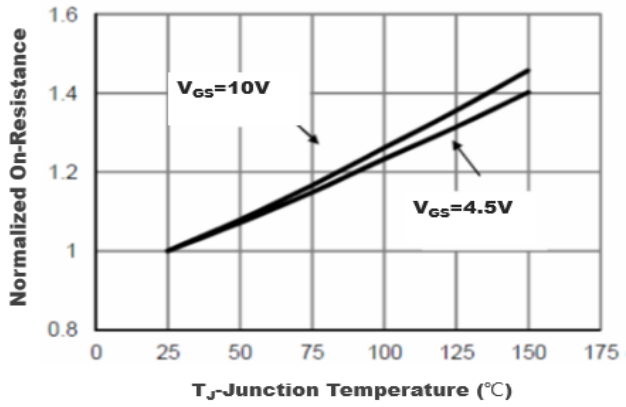
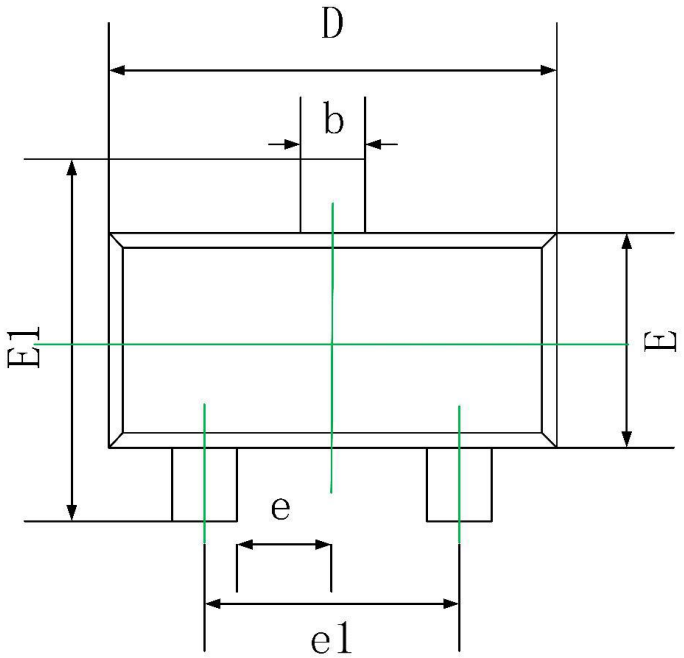
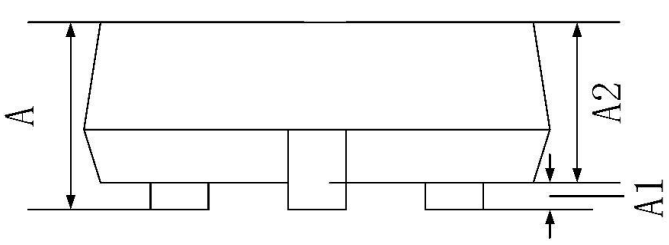
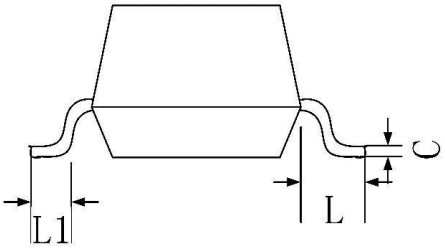


Figure6. Drain-Source on Resistance

SOT-23 Package Information







Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP.		0.037 TYP.	
e1	1.800	2.000	0.071	0.079
L	0.550 REF.		0.022 REF.	
L1	0.300	0.500	0.012	0.020

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